

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.19 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

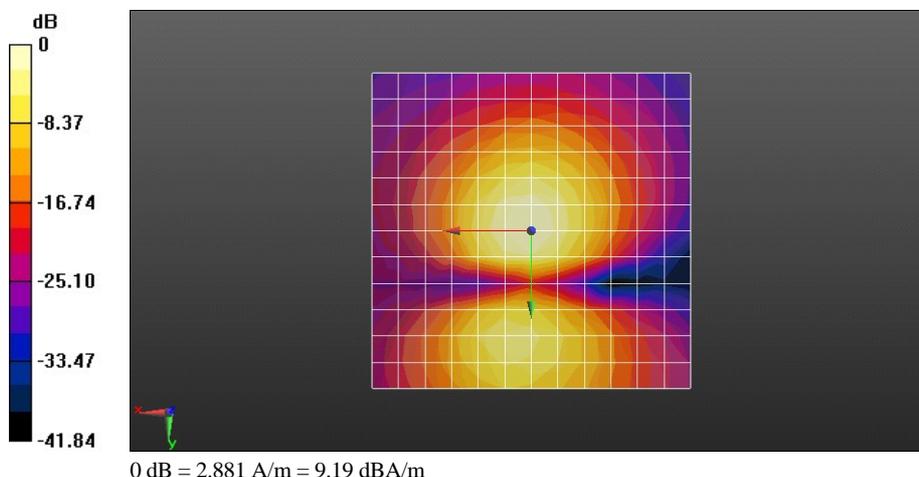
Cursor:

ABM1/ABM2 = 28.01 dB

ABM1 comp = 9.19 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm



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H867G-HAC(T-Coil)_GSM850 190CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 6.64 dBA/m

BWC Factor = 0.14 dB

Location: 0, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

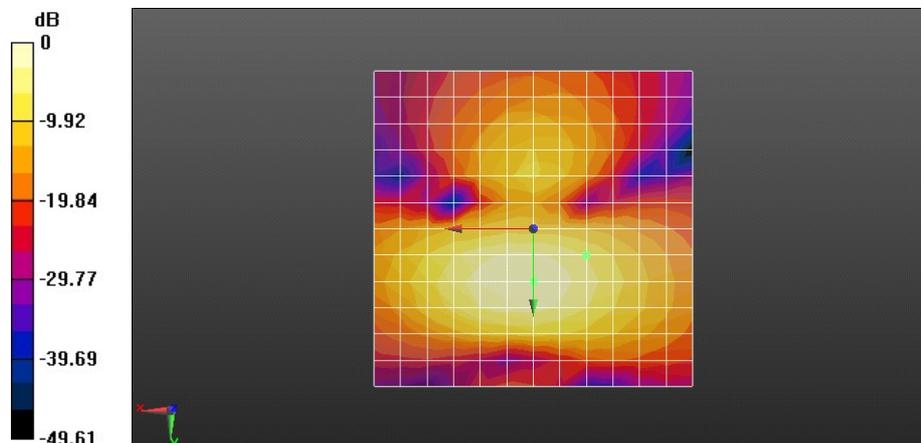
Cursor:

ABM1/ABM2 = 34.80 dB

ABM1 comp = -0.14 dBA/m

BWC Factor = 0.14 dB

Location: -8.3, 4.2, 3.7 mm



0 dB = 2.147 A/m = 6.64 dBA/m

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = -0.60 dBA/m

BWC Factor = 0.14 dB

Location: -8.3, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

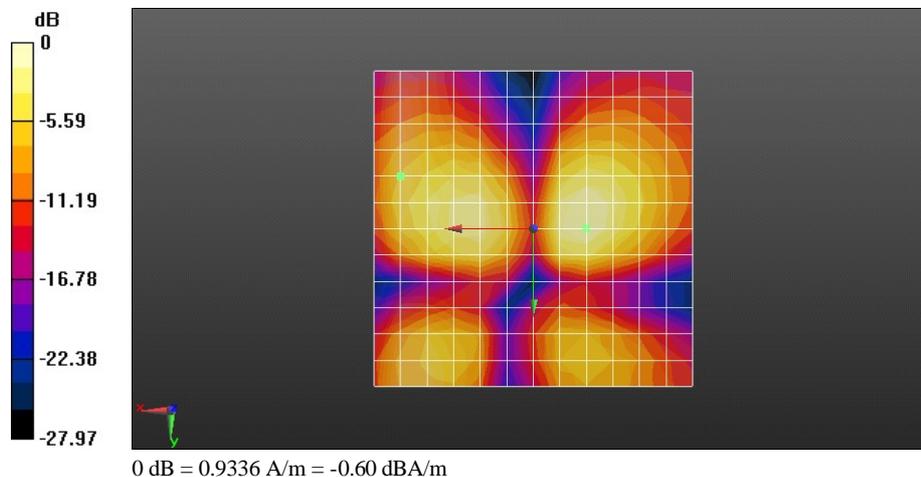
Cursor:

ABM1/ABM2 = 24.05 dB

ABM1 comp = -7.75 dBA/m

BWC Factor = 0.14 dB

Location: 20.8, -8.3, 3.7 mm



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H867G-HAC(T-Coil)_GSM850 190CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.75 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 29.62 dB

ABM1 comp = 10.75 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

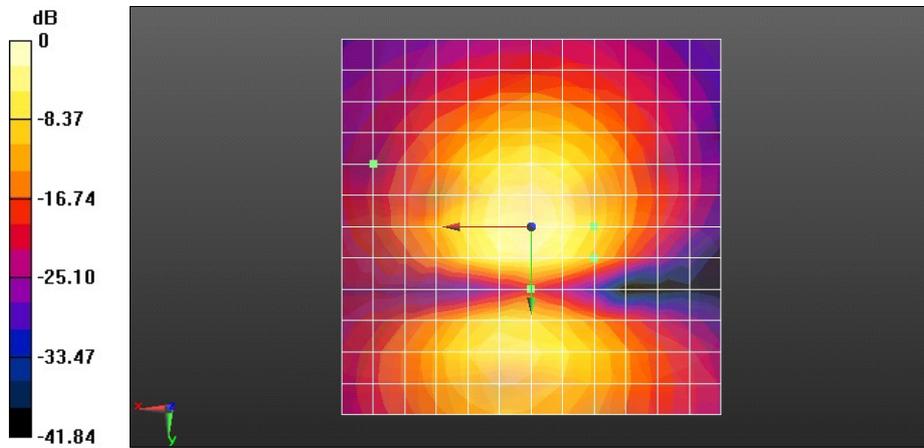
Device Reference Point: 0, 0, -6.3 mm

Cursor:

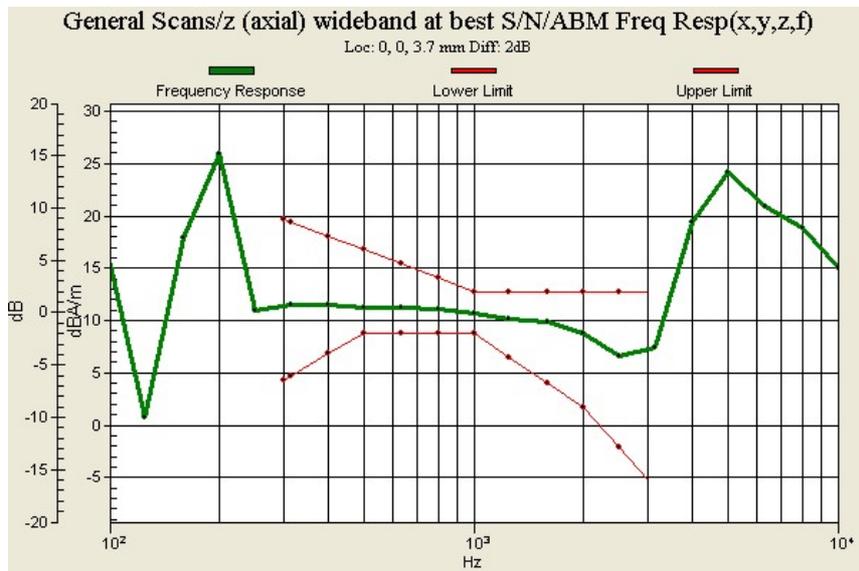
Diff = 2.00 dB

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm



0 dB = 2.881 A/m = 9.19 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.28 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

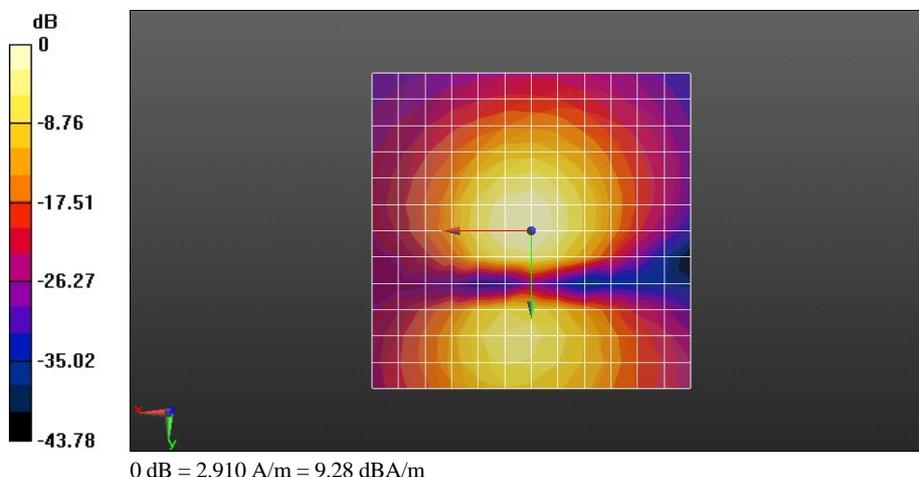
Cursor:

ABM1/ABM2 = 28.73 dB

ABM1 comp = 9.28 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 6.63 dBA/m

BWC Factor = 0.14 dB

Location: 0, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

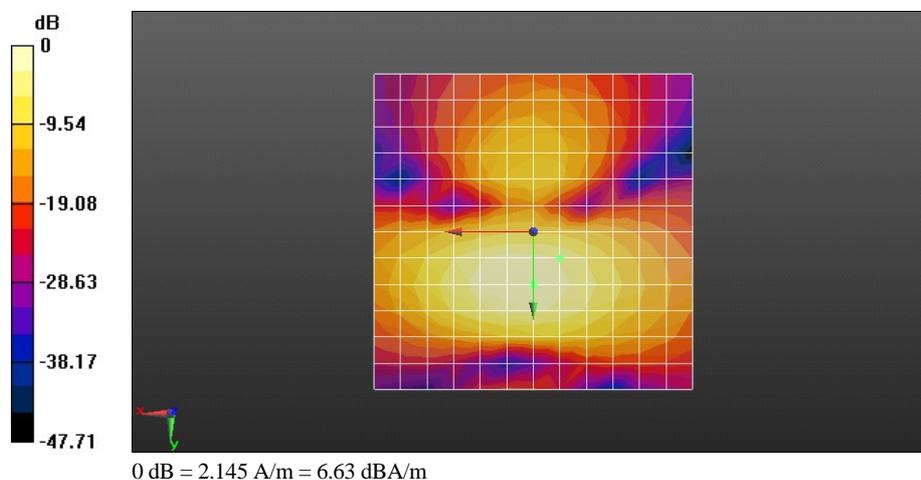
Cursor:

ABM1/ABM2 = 34.78 dB

ABM1 comp = 3.13 dBA/m

BWC Factor = 0.14 dB

Location: -4.2, 4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-1# -1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = -0.82 dBA/m

BWC Factor = 0.14 dB

Location: -8.3, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

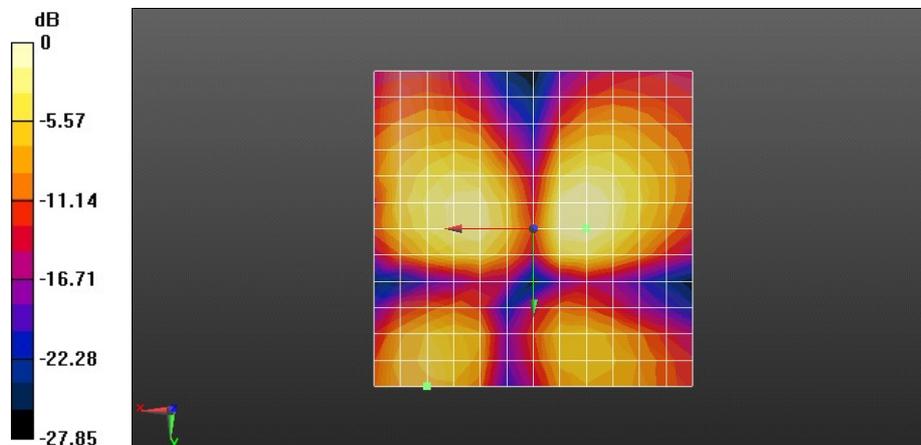
Cursor:

ABM1/ABM2 = 24.65 dB

ABM1 comp = -8.77 dBA/m

BWC Factor = 0.14 dB

Location: 16.7, 25, 3.7 mm



0 dB = 0.9097 A/m = -0.82 dBA/m

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.71 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 30.23 dB

ABM1 comp = 10.71 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

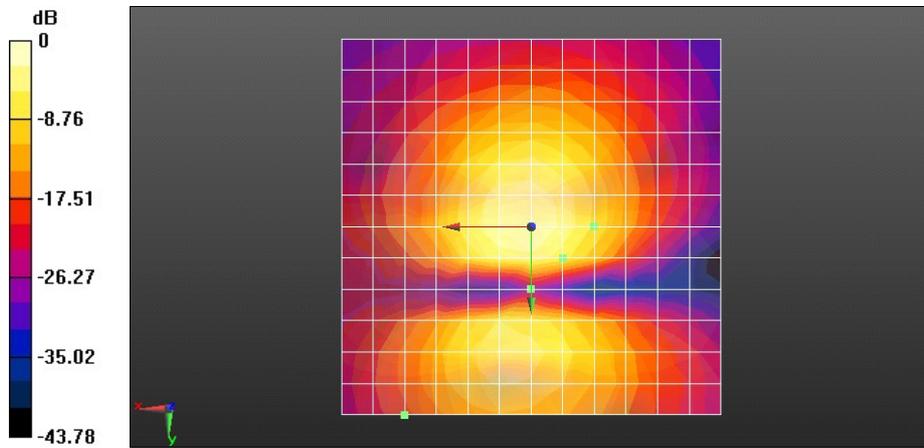
Device Reference Point: 0, 0, -6.3 mm

Cursor:

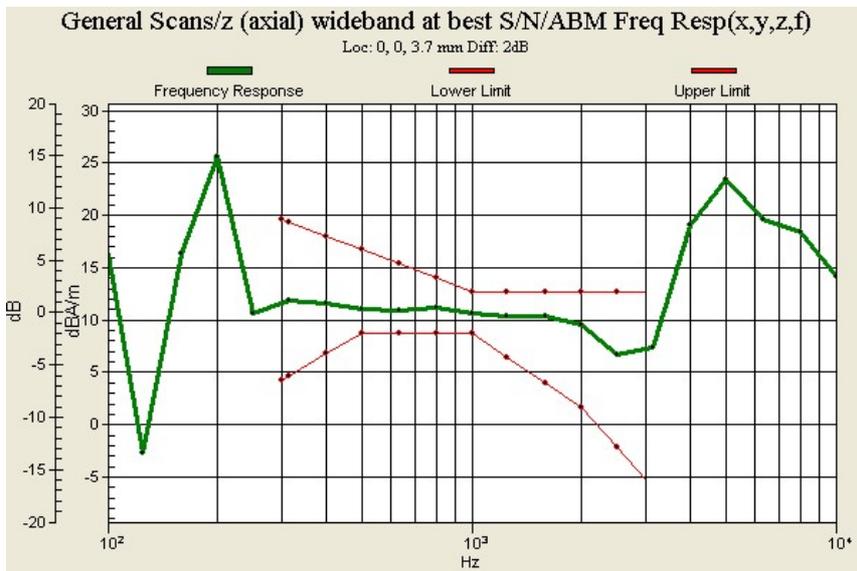
Diff = 2.00 dB

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm



0 dB = 2.910 A/m = 9.28 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.87 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

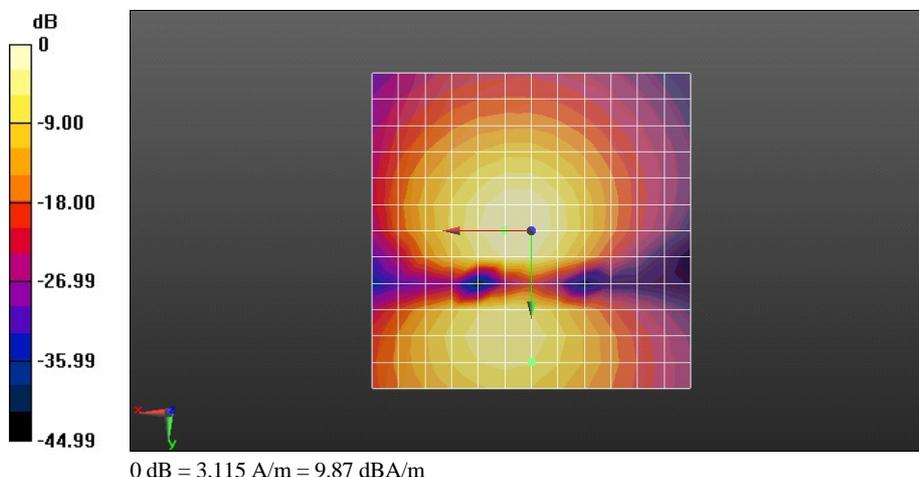
Cursor:

ABM1/ABM2 = 36.94 dB

ABM1 comp = 4.08 dBA/m

BWC Factor = 0.15 dB

Location: 0, 20.8, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.42 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

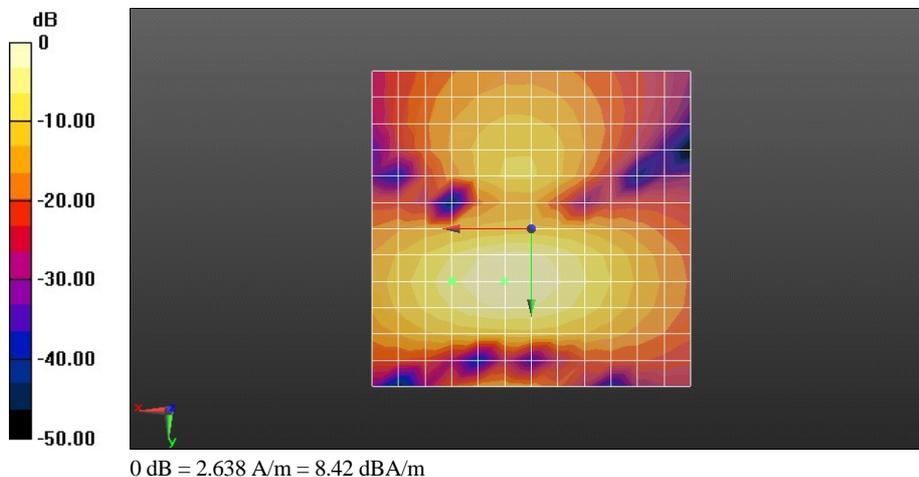
Cursor:

ABM1/ABM2 = 37.22 dB

ABM1 comp = 4.20 dBA/m

BWC Factor = 0.15 dB

Location: 12.5, 8.3, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.38 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

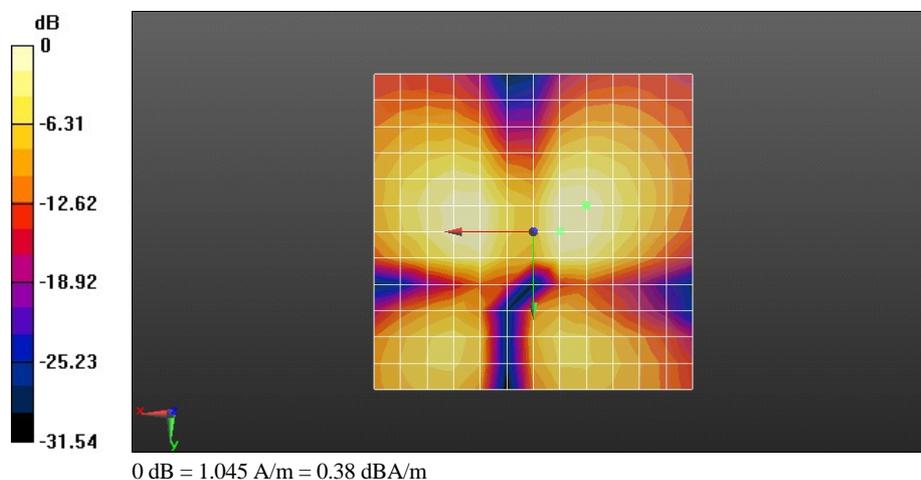
Cursor:

ABM1/ABM2 = 36.63 dB

ABM1 comp = 0.03 dBA/m

BWC Factor = 0.15 dB

Location: -8.3, -4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 4.51 dBA/m

BWC Factor = 10.78 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 37.33 dB

ABM1 comp = 4.51 dBA/m

BWC Factor = 10.78 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

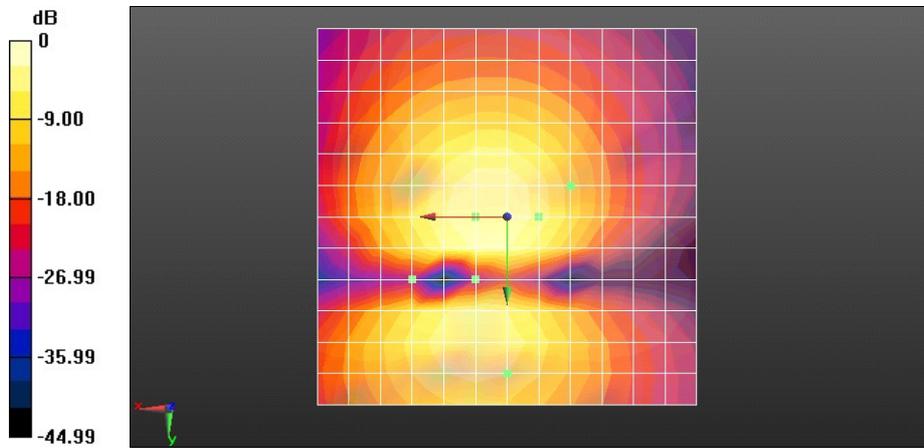
Device Reference Point: 0, 0, -6.3 mm

Cursor:

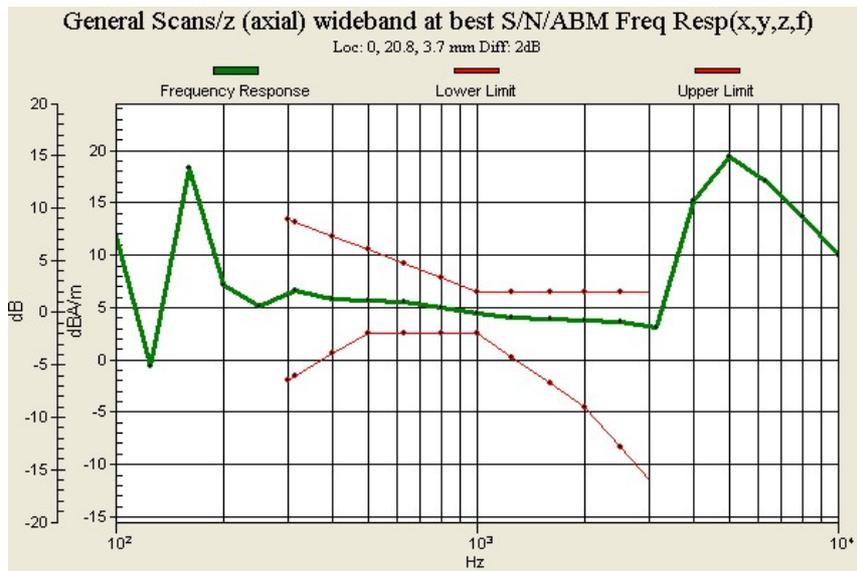
Diff = 2.00 dB

BWC Factor = 10.78 dB

Location: 0, 20.8, 3.7 mm



0 dB = 3.115 A/m = 9.87 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.92 dBA/m

BWC Factor = 0.15 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

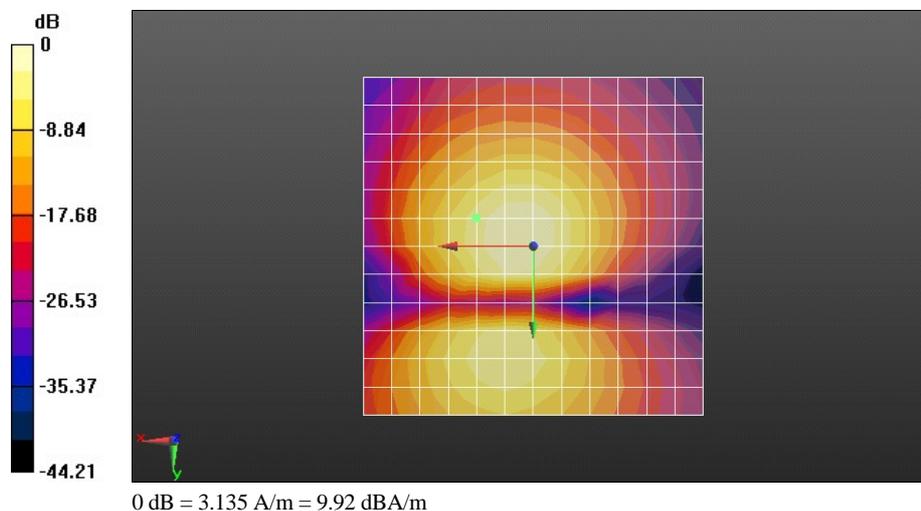
Cursor:

ABM1/ABM2 = 37.64 dB

ABM1 comp = 5.83 dBA/m

BWC Factor = 0.15 dB

Location: 8.3, -4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.43 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

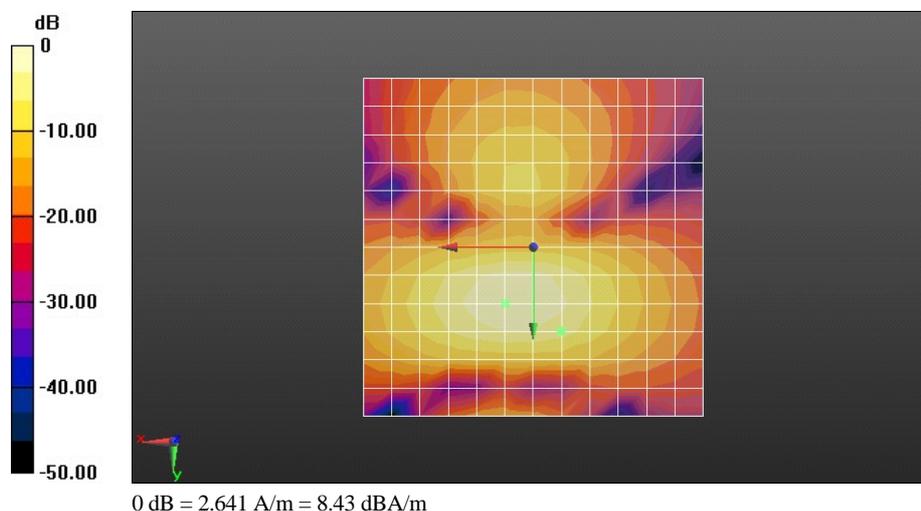
Cursor:

ABM1/ABM2 = 37.73 dB

ABM1 comp = 3.50 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, 12.5, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.08 dBA/m

BWC Factor = 0.15 dB

Location: 8.3, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

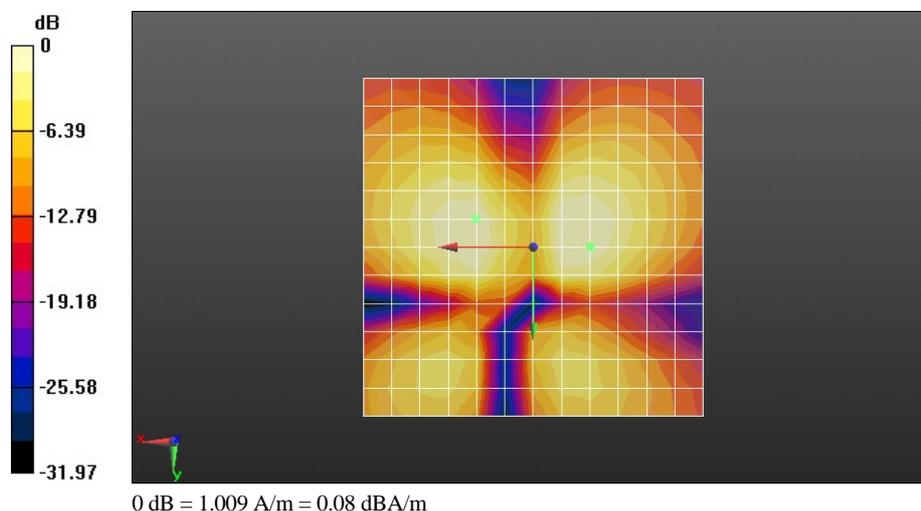
Cursor:

ABM1/ABM2 = 37.22 dB

ABM1 comp = -0.15 dBA/m

BWC Factor = 0.15 dB

Location: -8.3, 0, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 6.41 dBA/m

BWC Factor = 10.79 dB

Location: 8.3, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 37.95 dB

ABM1 comp = 6.41 dBA/m

BWC Factor = 10.79 dB

Location: 8.3, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

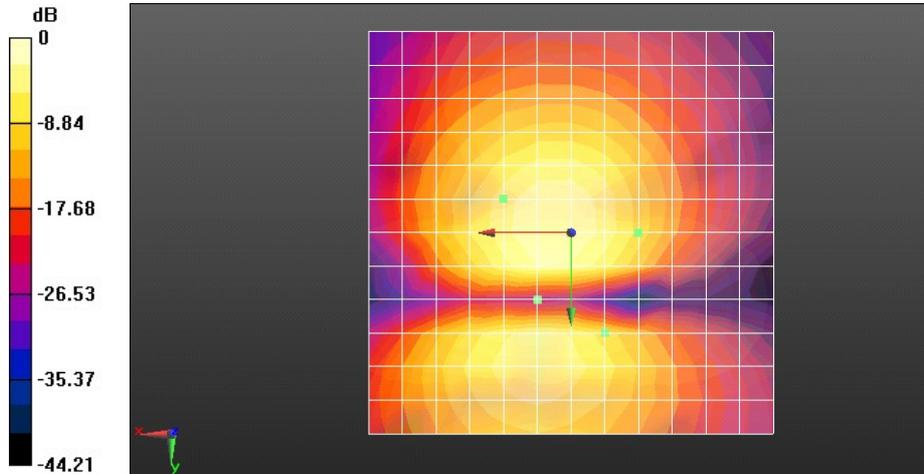
Device Reference Point: 0, 0, -6.3 mm

Cursor:

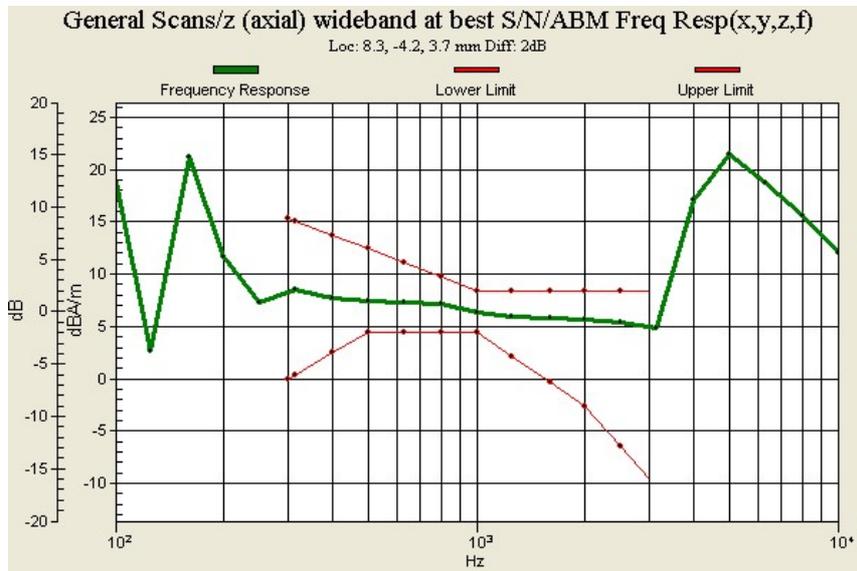
Diff = 2.00 dB

BWC Factor = 10.79 dB

Location: 8.3, -4.2, 3.7 mm



0 dB = 3.135 A/m = 9.92 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.03 dBA/m

BWC Factor = 0.15 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

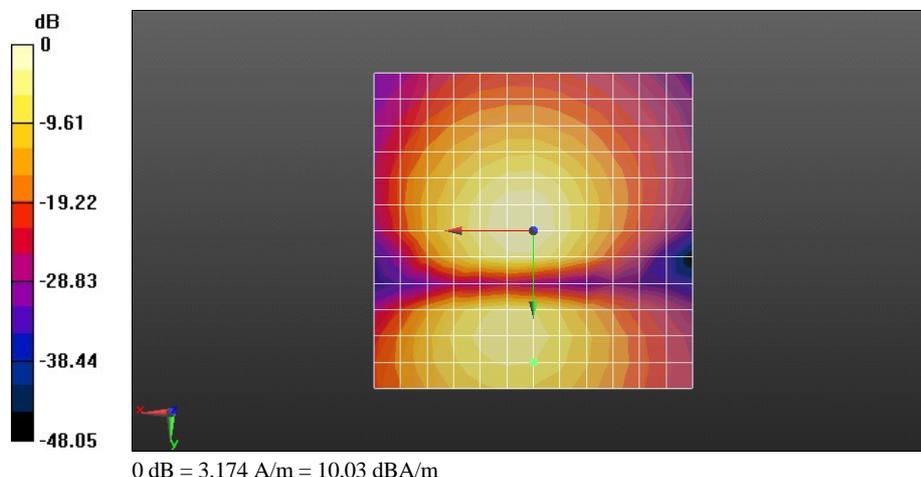
Cursor:

ABM1/ABM2 = 37.62 dB

ABM1 comp = 3.73 dBA/m

BWC Factor = 0.15 dB

Location: 0, 20.8, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-1#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.28 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

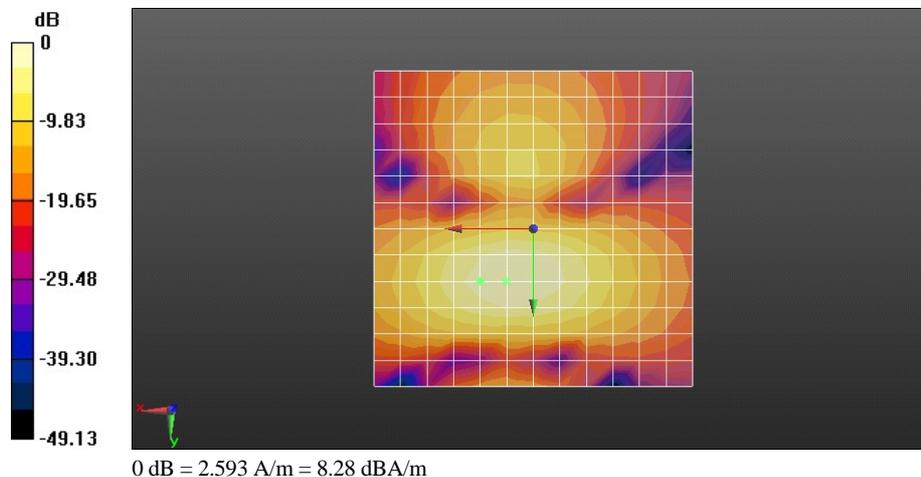
Cursor:

ABM1/ABM2 = 37.60 dB

ABM1 comp = 6.83 dBA/m

BWC Factor = 0.15 dB

Location: 8.3, 8.3, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.09 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

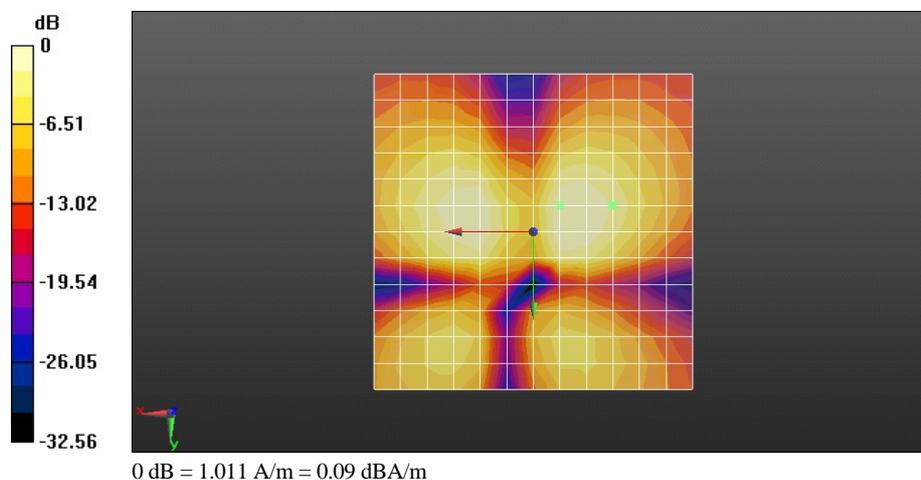
Cursor:

ABM1/ABM2 = 37.15 dB

ABM1 comp = -2.37 dBA/m

BWC Factor = 0.15 dB

Location: -12.5, -4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-1#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 4.39 dBA/m

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 38.22 dB

ABM1 comp = 4.39 dBA/m

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

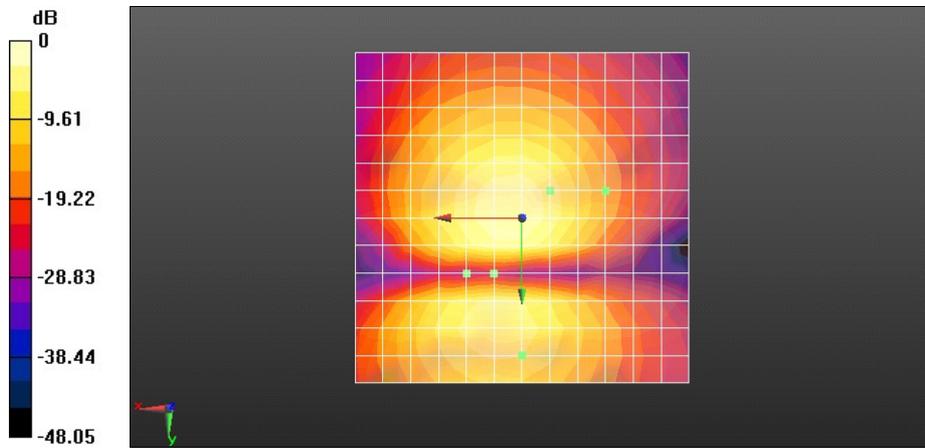
Device Reference Point: 0, 0, -6.3 mm

Cursor:

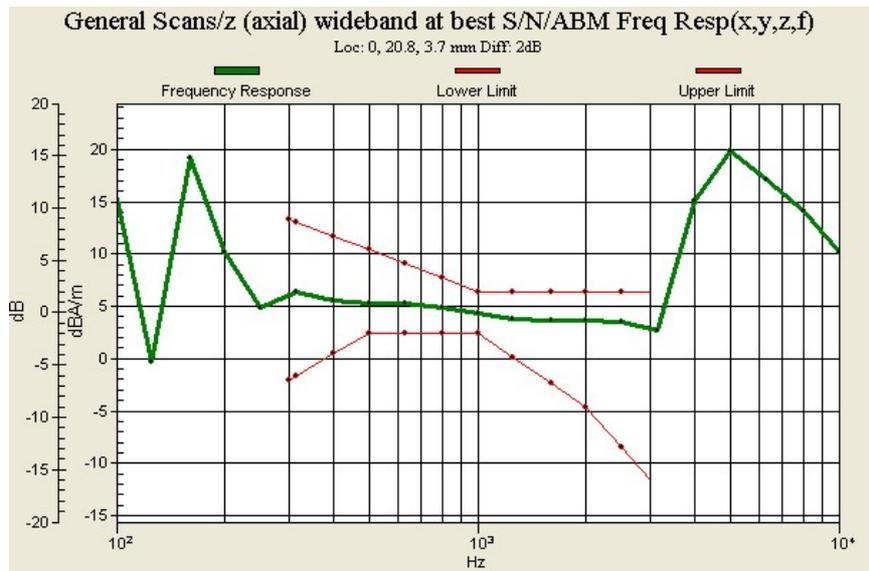
Diff = 2.00 dB

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm



0 dB = 3.174 A/m = 10.03 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.90 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

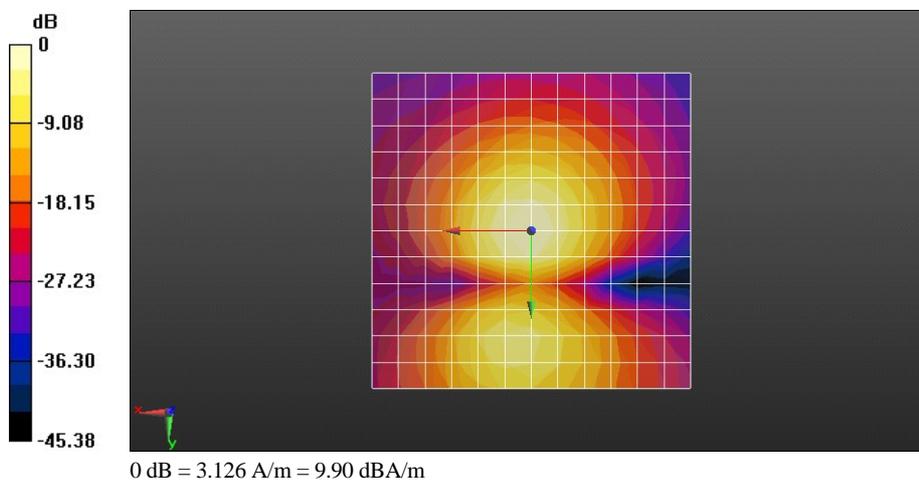
Cursor:

ABM1/ABM2 = 28.80 dB

ABM1 comp = 9.90 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 6.81 dBA/m

BWC Factor = 0.14 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

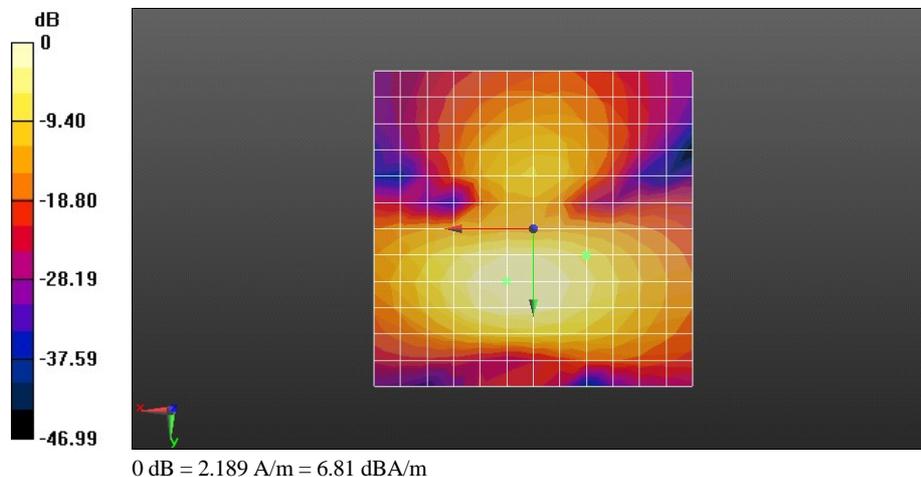
Cursor:

ABM1/ABM2 = 34.65 dB

ABM1 comp = -0.42 dBA/m

BWC Factor = 0.14 dB

Location: -8.3, 4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = -0.31 dBA/m

BWC Factor = 0.14 dB

Location: 8.3, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

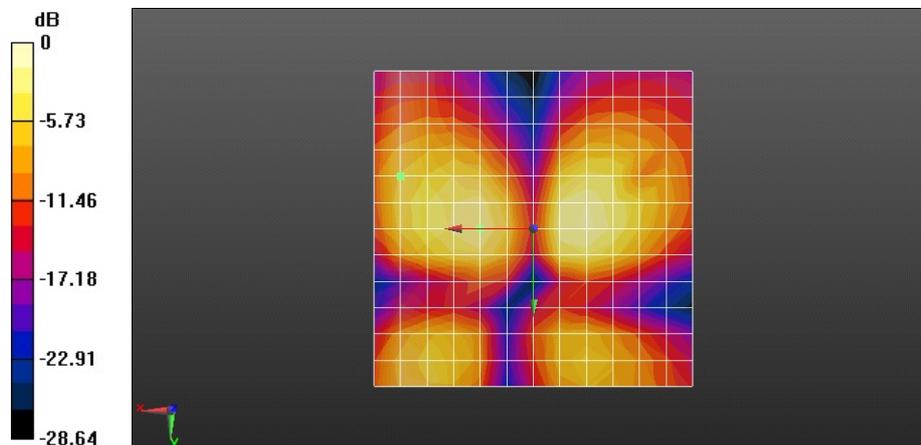
Cursor:

ABM1/ABM2 = 25.28 dB

ABM1 comp = -7.70 dBA/m

BWC Factor = 0.14 dB

Location: 20.8, -8.3, 3.7 mm



0 dB = 0.9647 A/m = -0.31 dBA/m

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM850 190CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.77 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.87 dBA/m

BWC Factor = 10.77 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.77 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 29.69 dB

ABM1 comp = 10.87 dBA/m

BWC Factor = 10.77 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.77 dB

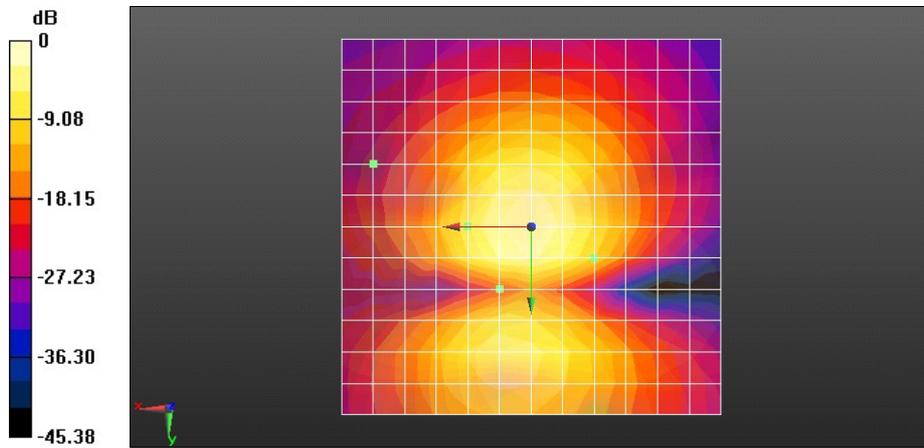
Device Reference Point: 0, 0, -6.3 mm

Cursor:

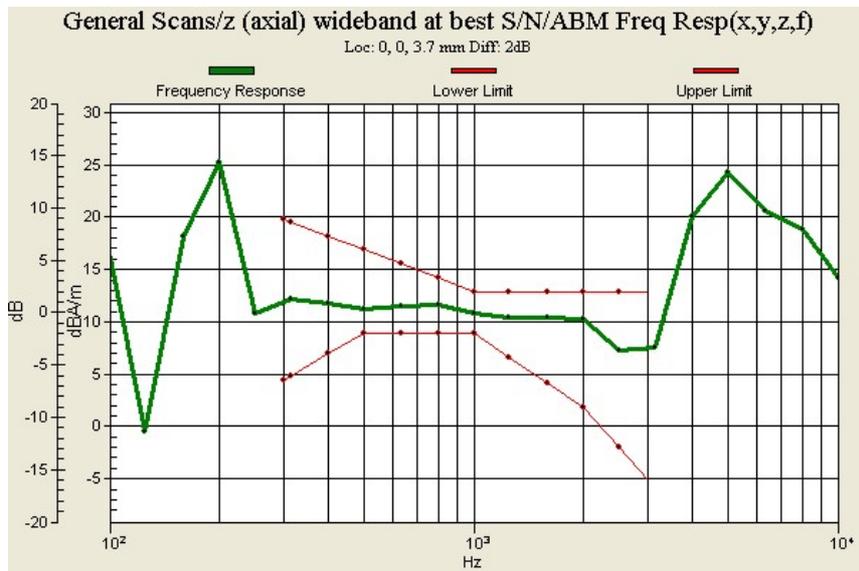
Diff = 2.00 dB

BWC Factor = 10.77 dB

Location: 0, 0, 3.7 mm



0 dB = 3.126 A/m = 9.90 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 9.73 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

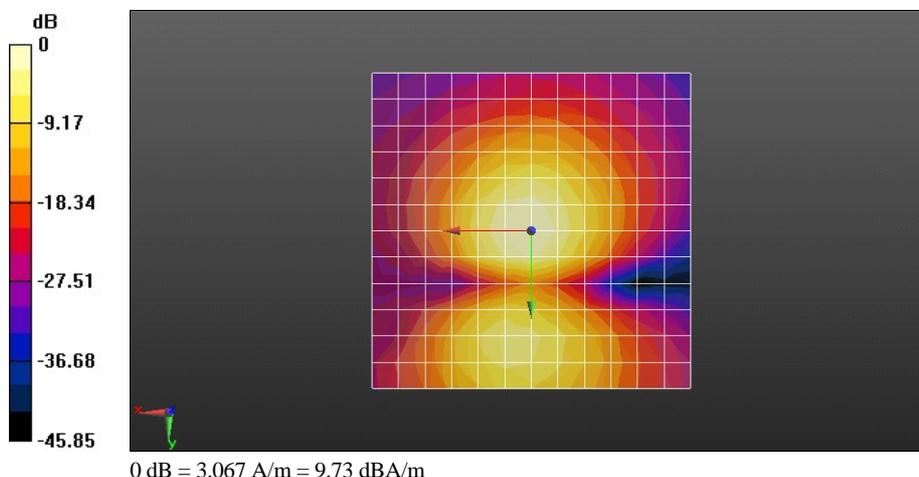
Cursor:

ABM1/ABM2 = 29.14 dB

ABM1 comp = 9.73 dBA/m

BWC Factor = 0.14 dB

Location: 0, 0, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 6.89 dBA/m

BWC Factor = 0.14 dB

Location: 0, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

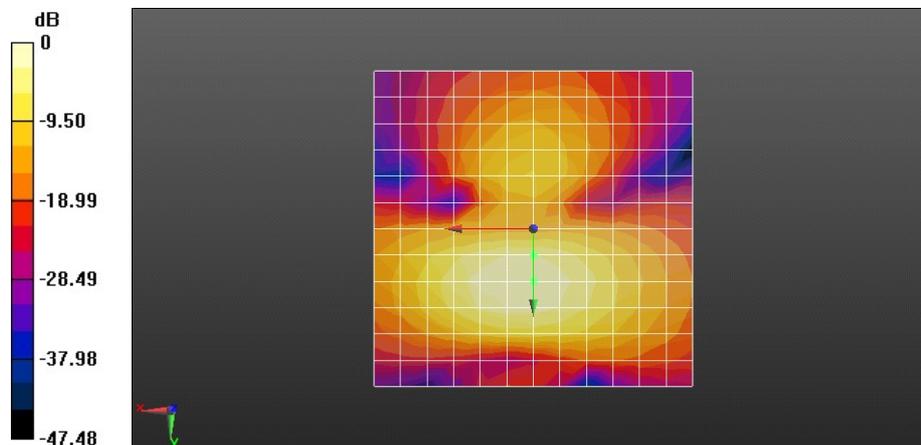
Cursor:

ABM1/ABM2 = 34.81 dB

ABM1 comp = 3.98 dBA/m

BWC Factor = 0.14 dB

Location: 0, 4.2, 3.7 mm



0 dB = 2.211 A/m = 6.89 dBA/m

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = -0.44 dBA/m

BWC Factor = 0.14 dB

Location: -8.3, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.14 dB

Device Reference Point: 0, 0, -6.3 mm

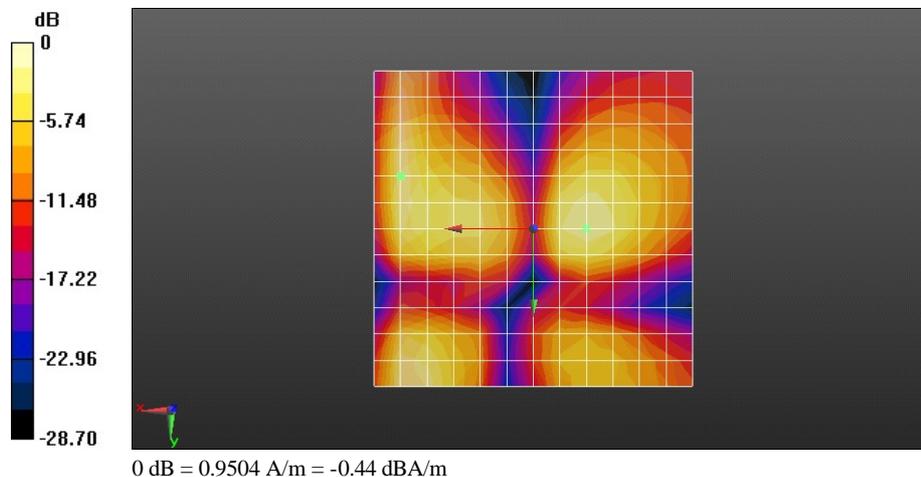
Cursor:

ABM1/ABM2 = 25.37 dB

ABM1 comp = -7.75 dBA/m

BWC Factor = 0.14 dB

Location: 20.8, -8.3, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_GSM1900 661CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-GSM\GPRS\EGPRS-1TS; Frequency: 1880 MHz;Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 11.00 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 30.49 dB

ABM1 comp = 11.00 dBA/m

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

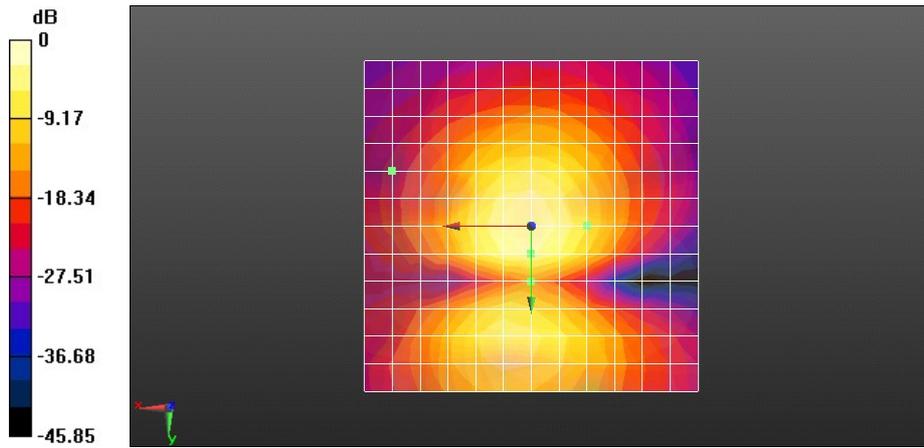
Device Reference Point: 0, 0, -6.3 mm

Cursor:

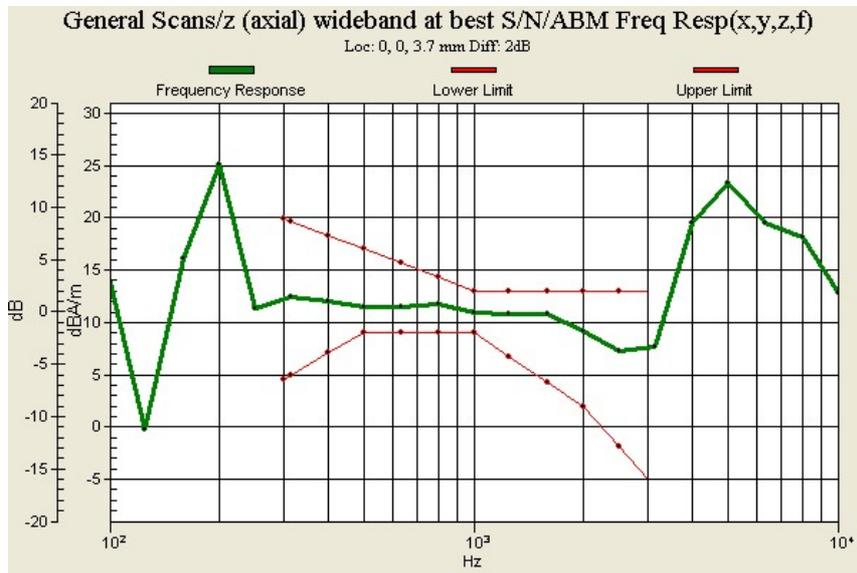
Diff = 2.00 dB

BWC Factor = 10.78 dB

Location: 0, 0, 3.7 mm



0 dB = 3.067 A/m = 9.73 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.06 dBA/m

BWC Factor = 0.15 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

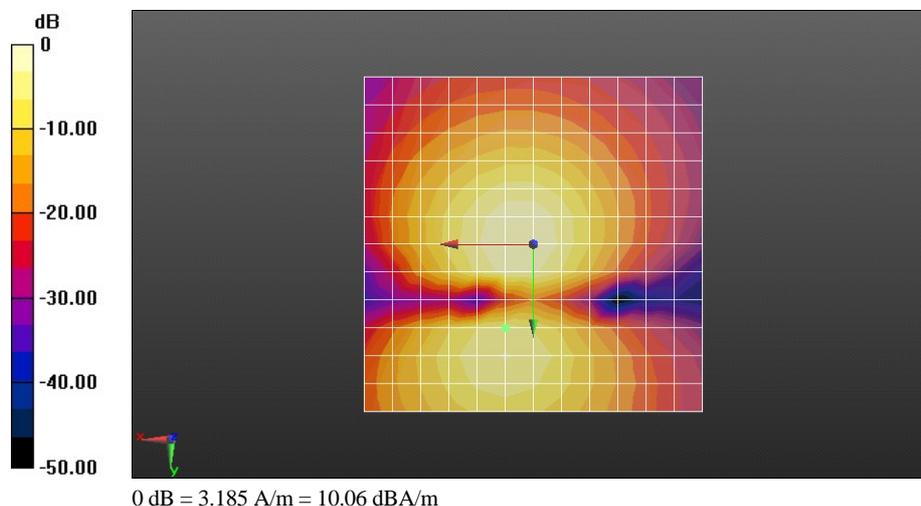
Cursor:

ABM1/ABM2 = 37.20 dB

ABM1 comp = 5.15 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 12.5, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)**(13x13x1)**: Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.23 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)**(13x13x1)**: Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

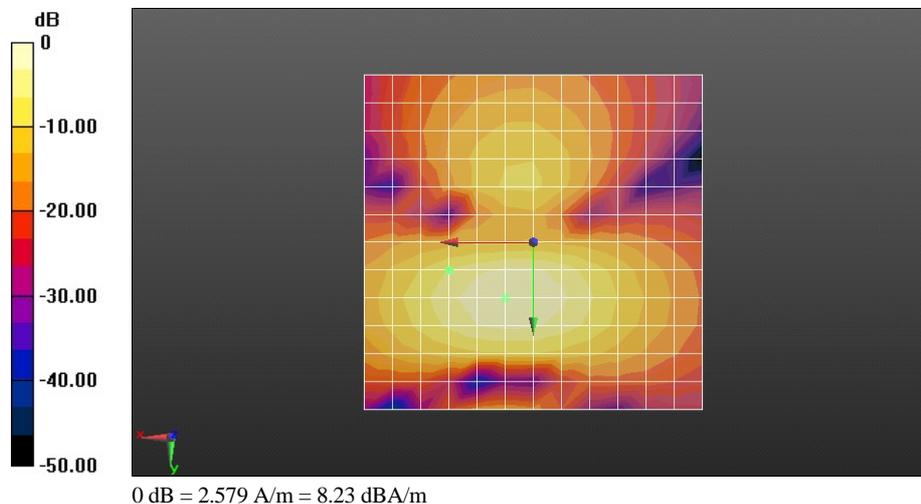
Cursor:

ABM1/ABM2 = 37.01 dB

ABM1 comp = 1.84 dBA/m

BWC Factor = 0.15 dB

Location: 12.5, 4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.33 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

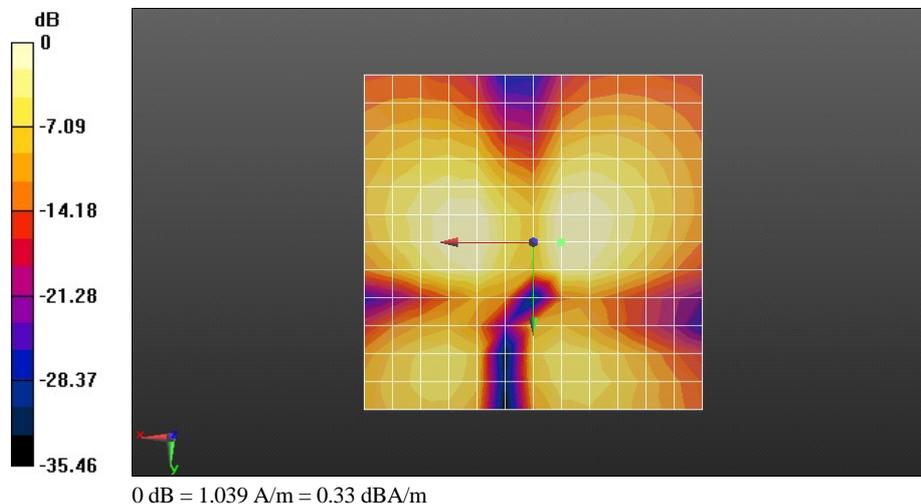
Cursor:

ABM1/ABM2 = 36.64 dB

ABM1 comp = 0.33 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, 0, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band II 9400CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 5.97 dBA/m

BWC Factor = 10.79 dB

Location: 4.2, 12.5, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 37.50 dB

ABM1 comp = 5.97 dBA/m

BWC Factor = 10.79 dB

Location: 4.2, 12.5, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

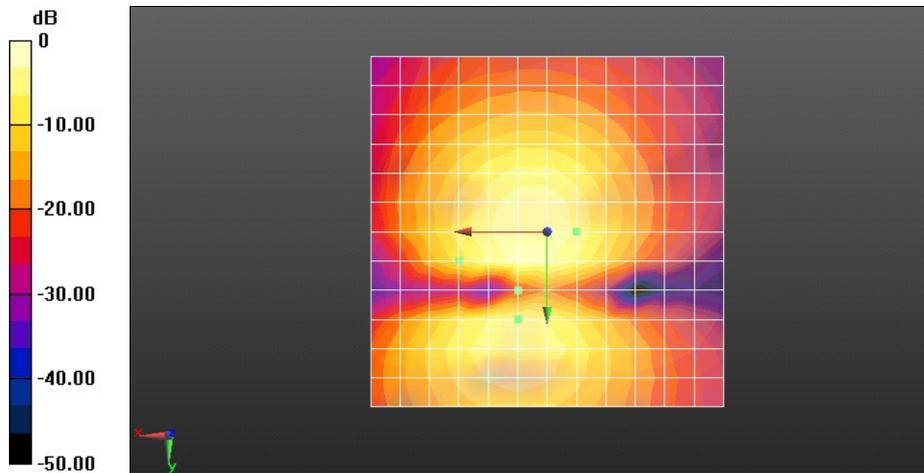
Device Reference Point: 0, 0, -6.3 mm

Cursor:

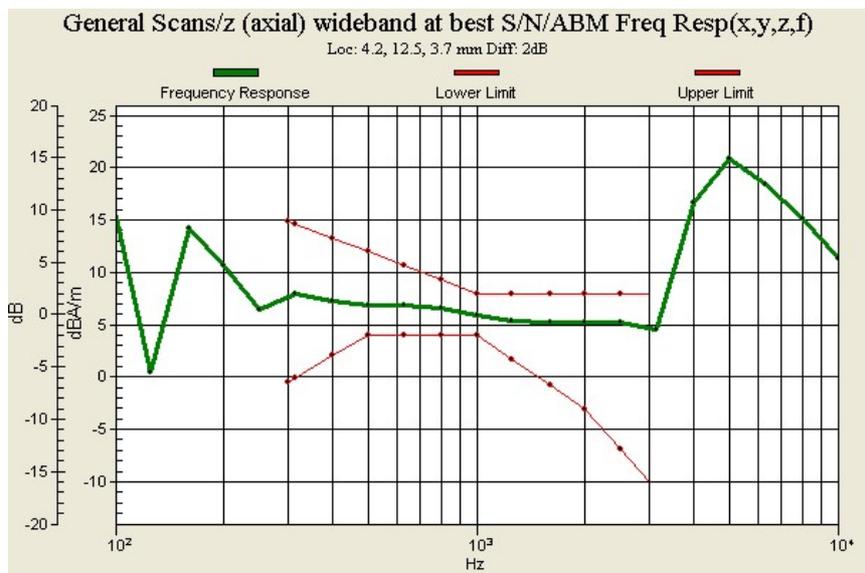
Diff = 2.00 dB

BWC Factor = 10.79 dB

Location: 4.2, 12.5, 3.7 mm



0 dB = 3.185 A/m = 10.06 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.06 dBA/m

BWC Factor = 0.15 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

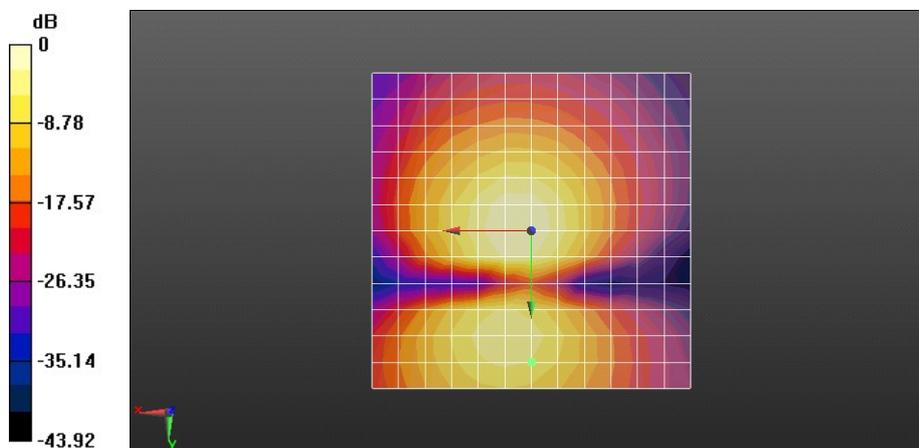
Cursor:

ABM1/ABM2 = 37.66 dB

ABM1 comp = 4.09 dBA/m

BWC Factor = 0.15 dB

Location: 0, 20.8, 3.7 mm



0 dB = 3.184 A/m = 10.06 dBA/m

Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.29 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

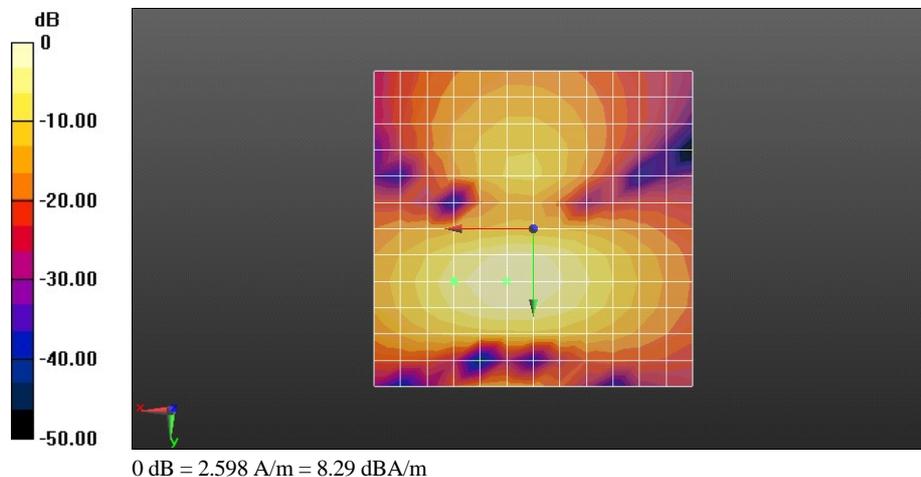
Cursor:

ABM1/ABM2 = 37.53 dB

ABM1 comp = 3.93 dBA/m

BWC Factor = 0.15 dB

Location: 12.5, 8.3, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI**

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.00 dBA/m

BWC Factor = 0.15 dB

Location: -8.3, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR**(x,y,z) (13x13x1):** Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

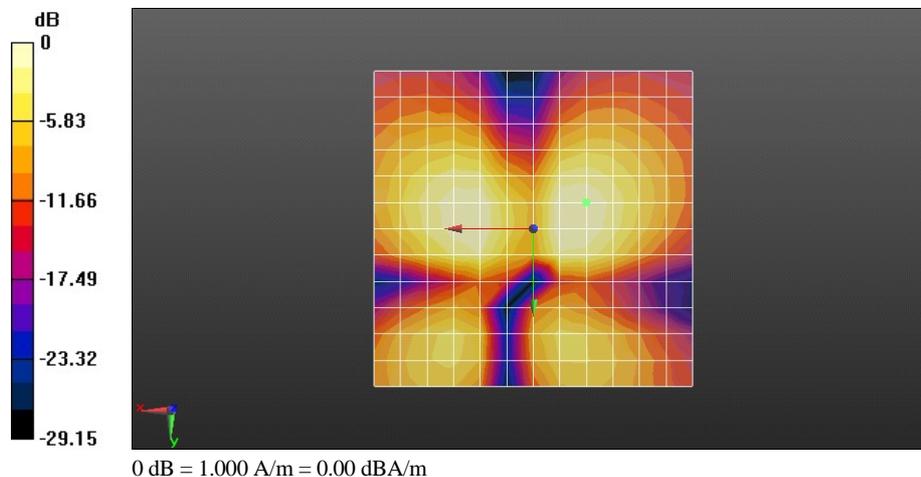
Cursor:

ABM1/ABM2 = 37.28 dB

ABM1 comp = 0.00 dBA/m

BWC Factor = 0.15 dB

Location: -8.3, -4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band IV 1413CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 1732.6 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 4.52 dBA/m

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 38.03 dB

ABM1 comp = 4.52 dBA/m

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.79 dB

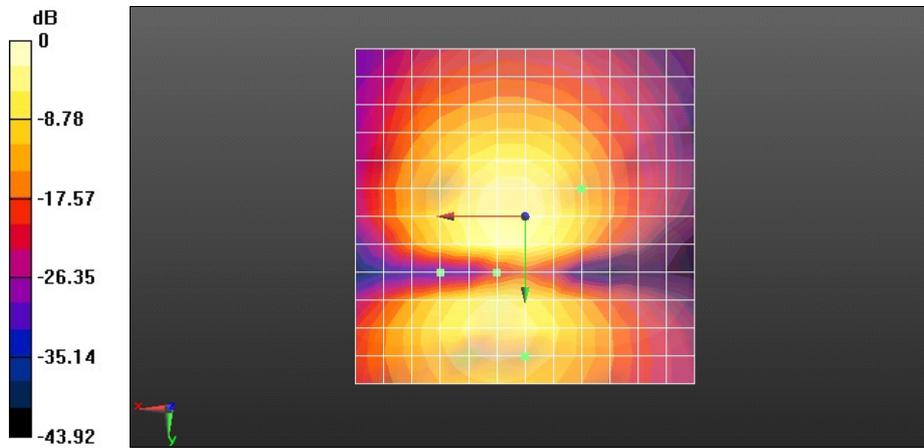
Device Reference Point: 0, 0, -6.3 mm

Cursor:

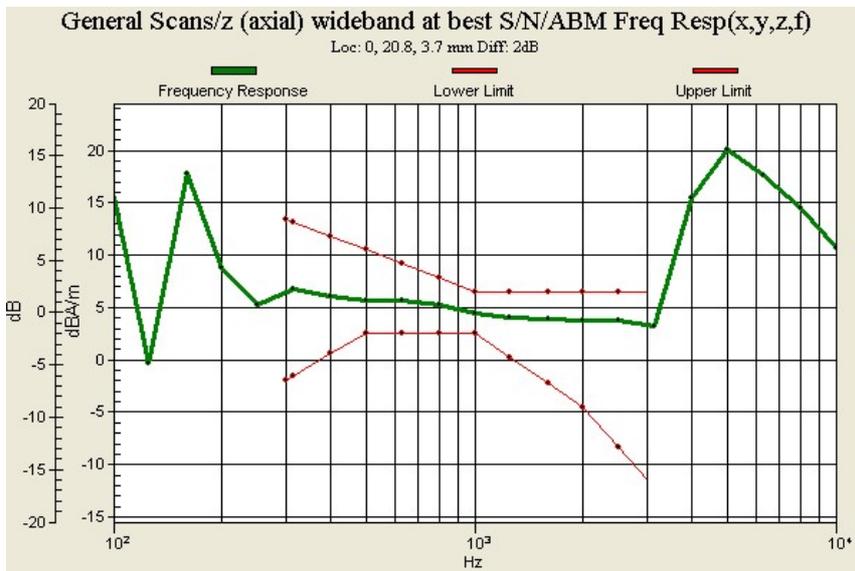
Diff = 2.00 dB

BWC Factor = 10.79 dB

Location: 0, 20.8, 3.7 mm



0 dB = 3.184 A/m = 10.06 dBA/m



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-2#**DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1**

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 10.00 dBA/m

BWC Factor = 0.15 dB

Location: 0, 0, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) 4.2mm 50 x 50/ABM SNR(x,y,z) (13x13x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

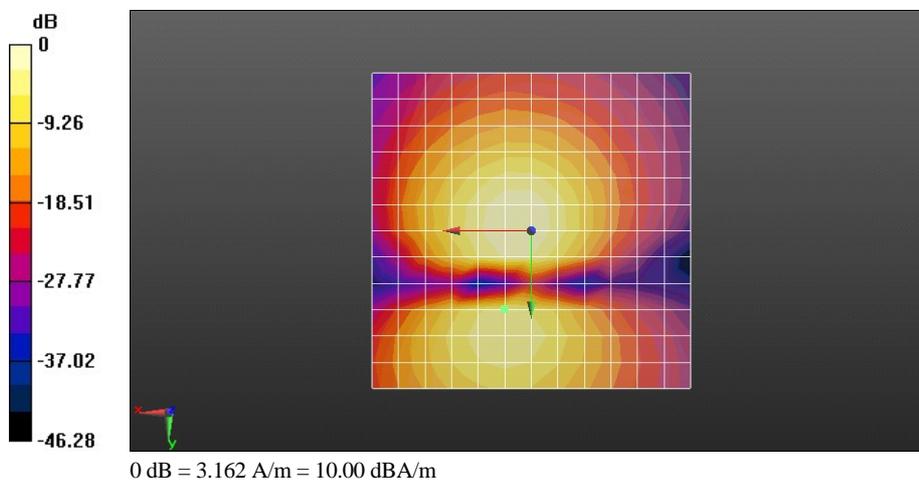
Cursor:

ABM1/ABM2 = 37.83 dB

ABM1 comp = 5.54 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 12.5, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM Signal(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 8.26 dBA/m

BWC Factor = 0.15 dB

Location: 4.2, 8.3, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/y (transversal) 4.2mm 50 x 50/ABM SNR(x,y,z)

(13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

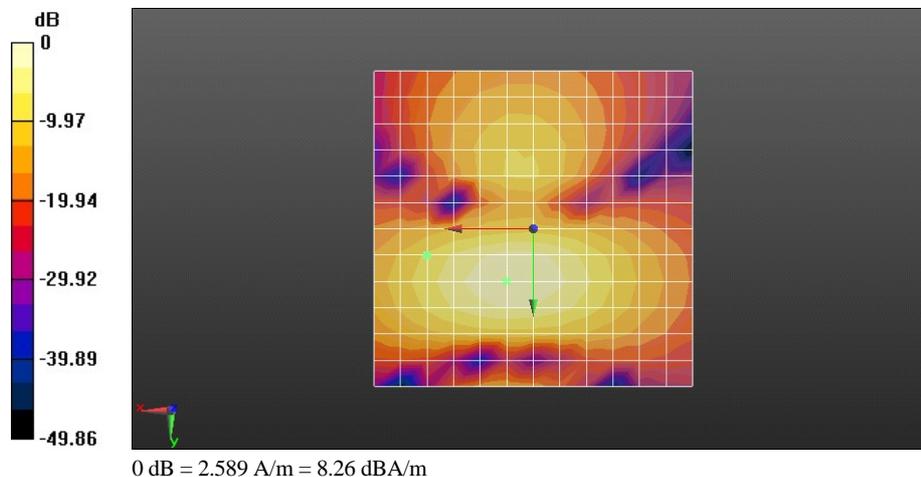
Cursor:

ABM1/ABM2 = 37.65 dB

ABM1 comp = -0.93 dBA/m

BWC Factor = 0.15 dB

Location: 16.7, 4.2, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SAR1

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM Signal

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 0.29 dBA/m

BWC Factor = 0.15 dB

Location: -4.2, -4.2, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/x (longitudinal) (2007) 4.2mm 50 x 50/ABM SNR

(x,y,z) (13x13x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 30.34

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.15 dB

Device Reference Point: 0, 0, -6.3 mm

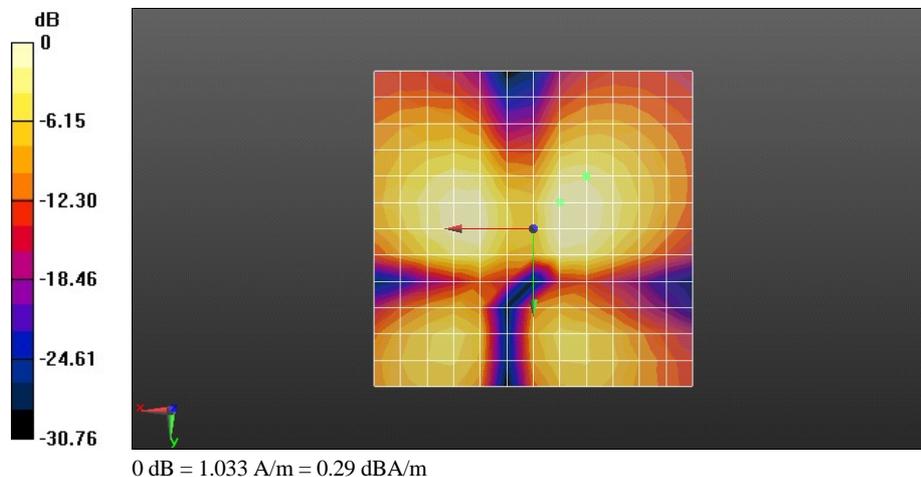
Cursor:

ABM1/ABM2 = 37.37 dB

ABM1 comp = -2.11 dBA/m

BWC Factor = 0.15 dB

Location: -8.3, -8.3, 3.7 mm



Test Laboratory: HUAWEI SAR/HAC Lab

H867G-HAC(T-Coil)_UMTS Band V 4182CH-2#

DUT: H867G; Type: HSPA/UMTS/GPRS/GSM/EDGE Mobile Phone with Bluetooth; Serial: SARI

Communication System: HW-UMTS-FDD; Frequency: 836.4 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 0$ kg/m³

Phantom section: TCoil Section

DASY Configuration:

- Probe: AM1DV3 - 3067; ; Calibrated: 2011-12-8
- Sensor-Surface: 0mm (Fix Surface), z = 3.0
- Electronics: DAE4 Sn913; Calibrated: 2011-12-23
- Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; Serial: 1053
- DASY52 52.8.3(988); SEMCAD X 14.6.7(6848)

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Signal(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1 comp = 5.56 dBA/m

BWC Factor = 10.78 dB

Location: 4.2, 12.5, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM SNR(x,y,z)

(1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

Device Reference Point: 0, 0, -6.3 mm

Cursor:

ABM1/ABM2 = 38.17 dB

ABM1 comp = 5.56 dBA/m

BWC Factor = 10.78 dB

Location: 4.2, 12.5, 3.7 mm

T-Coil scan (scan for ANSI C63.19-2007 & 2011 compliance)/General Scans/z (axial) wideband at best S/N/ABM Freq Resp

(x,y,z,f) (1x1x1): Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav

Output Gain: 59.41

Measure Window Start: 300ms

Measure Window Length: 2000ms

BWC applied: 10.78 dB

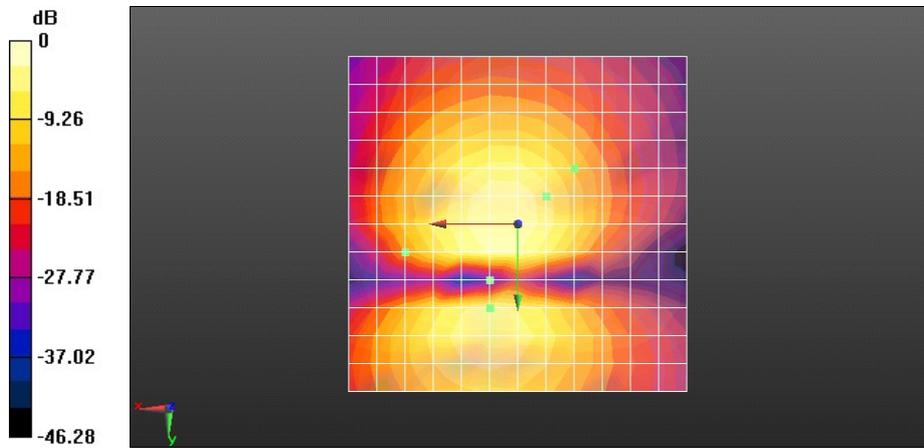
Device Reference Point: 0, 0, -6.3 mm

Cursor:

Diff = 2.00 dB

BWC Factor = 10.78 dB

Location: 4.2, 12.5, 3.7 mm



0 dB = 3.162 A/m = 10.00 dBA/m

